/VI/IXI/VI 500MHz, Low-Power, Current-Mode Feedback Amplifiers

General Description

The MAX4112/MAX4113 current-mode feedback amplifiers combine high-speed performance with low-power operation. The MAX4112 is optimized for closed-loop gains of 2V/V or greater, while the MAX4113 is optimized for gains of 8V/V or greater.

The MAX4112/MAX4113 require only 5mA of supply current and deliver bandwidths of 500MHz (Ay $\ge 2V/V$) and 275MHz (Av \geq 8V/V), respectively. The high slew rates (1200V/µs and 1800V/µs) provide exceptional fullpower bandwidths (300MHz and 250MHz), making these amplifiers ideal for high-performance pulse and RGB video applications.

These high-speed op amps have a wide output voltage swing of ± 3.5 V into 100Ω and a high current-drive capability of 80mA.

Applications

Broadcast and High-Definition TV Systems **RGB** Video Pulse/RF Amplifier Ultrasound Active Filters ADC Buffers

Typical Application Circuit

- Features 500MHz -3dB Bandwidth (MAX4112) 275MHz -3dB Bandwidth (MAX4113)
- 0.1dB Gain Flatness to 30MHz (MAX4112)
- 1200V/µs Slew Rate (MAX4112) 1800V/µs Slew Rate (MAX4113)
- ♦ 300MHz Full-Power Bandwidth (Vo = 2Vp-p, MAX4112) 250MHz Full-Power Bandwidth $(V_0 = 2V_p - p, MAX4113)$
- + High Output Drive: 80mA
- + Low Power: 5mA Supply Current

Ordering Information

PART	TEMP. RANGE	PIN-PACKAGE		
MAX4112ESA	-40°C to +85°C	8 SO		
MAX4112EUA	-40°C to +85°C	8 µMAX*		
MAX4113ESA	-40°C to +85°C	8 SO		

* Contact factory for µMAX package availability.

R_G 499Ω 499**Ω** TOP VIEW $\wedge \wedge$ MAXIM 8 N.C. N.C. 1 1000pl MAX4112 MAX4113 7 V+ IN- 2 75 Ω 75 Ω CABLE NAN V~{) 6 OUT IN+ 3 MAX4 75 Ω CABLE VIDEO OUT 75Ω 5 N.C. V-VIDEO IN uFГ 75Ω SO/µMAX* 1000pf -5V * Contact factory for MAX4112 µMAX package availability. VIDEO LINE DRIVER

Maxim Integrated Products 1 Call toll free 1-800-998-8800 for free samples or literature.

MAX4112/MAX4113

Pin Configuration

ABSOLUTE MAXIMUM RATINGS

Power Supply Voltage (V _{CC} to V _{EE})12V Voltage on Any Pin to Ground or Any Other PinV _{CC} to V _{EE} Short-Circuit Duration (V _{OUT} to GND)	
V _{IN} < 1.5VContinuous	
VIN > 1.5V0sec	
Continuous Power Dissipation ($T_A = +70^{\circ}C$)	
SO (derate 5.88mW/C above +70°C)471mW	
µMAX (derate 4.10mW/C above +70°C)	

Operating Temperature Range	
MAX4112E_A/MAX4113E_A40°C to +85°C	;
Storage Temperature Range65°C to +160°C	;
Lead Temperature (soldering, 10sec)+300°C	;

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

ELECTRICAL CHARACTERISTICS

(V_{CC} = 5V, V_{EE} = -5V, T_A = T_{MIN} to T_{MAX}, typical values are at T_A = +25°C, unless otherwise noted.)

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS
DC SPECIFICATIONS		1					
Input Offset Voltage	Vos	V _{OUT} = 0V			1	8	mV
Input Offset Voltage Drift	TCVOS	$V_{OUT} = 0V$			10		µV/°C
Positive Input Bias Current	IB+	Vout = 0V, VIN = -Vo)S		3.5	20	μΑ
Negative Input Bias Current	IB-	Vout = 0V, VIN = -Vo)S		3.5	20	μΑ
Input Decistopes		IN+			500		kΩ
Input Resistance		IN-			30		Ω
Input Capacitance		IN+			2		рF
Input Voltage Noise	en	f = 10kHz			2.2		nV/√Hz
Integrated Voltage Noise	EnRMS	f = 1MHz to 100MHz	f = 1MHz to 100MHz		27		μVrms
Positive Input Current Noise	i _{n+}	f = 10kHz	MAX4112		13	DA /0[pA/√Hz
Positive input current Noise			MAX4113		9		
Negative Input Current Noise	in-	f = 10kHz			14		pA/√Hz
Common-Mode Input Voltage	Vсм			-2.5		2.5	V
Common-Mode Rejection	CMR	$V_{CM} = \pm 2.5 V$		45	50		dB
Power-Supply Rejection	PSR	$V_{S} = \pm 4.5 V \text{ to } \pm 5.5 V$		60	80		dB
Open-Loop Transimpedance	Zol	V_{OUT} = ±2.0V, V_{CM} = 0V, R_L = 100 Ω		250	500		kΩ
Quiescent Supply Current	I _{SY}	$V_{IN} = 0V$			5	6.5	mA
Output Voltago Swing	wing Vaur	RL = ∞		±3.5	±3.8		V
Output Voltage Swing	Vout	$R_L = 100\Omega$		±3.1	±3.5		1
Output Current Drive	IOUT	$R_L = 30\Omega$, $T_A = 0^{\circ}C$ t	o +85°C	65	80		mA

MAX4112/MAX4113

PARAMETER	SYMBOL	CONDITIO	MIN	TYP	MAX	UNITS		
AC SPECIFICATIONS	1							
-3dB Bandwidth	DW/ a in	Vout ≤ 0.1V _{RMS}	MAX4112		500			
-30B Bandwidth	BW-3dB	VOUT S 0.1VRMS	MAX4113		275		MHz	
0.1dB Bandwidth	DW/a t in	MAX4112, Avcl = +2			30			
0. TOB Bandwidin	BW0.1dB	MAX4113, Avcl = +8			90		MHz	
Full-Power Bandwidth		1/2 21/2 2	MAX4112		300			
Full-Power Bandwidth	FPBW	$V_{O} = 2Vp-p$	MAX4113		250		MHz	
Slew Rate	SR	2V < V = < 2V	MAX4112		1200		V/µs	
		$-2V \le V_{OUT} \le 2V$	MAX4113		1800			
Settling Time	ts	to 0.1%, -1V ≤ V _{OUT} ≤ 1V,	MAX4112		15		- ns	
		$R_L = 100\Omega$	MAX4113		10			
		to 0.01%, -1V ≤ V _{OUT} ≤ 1V,	MAX4112		35			
		$R_{L} = 100\Omega$		25				
Rise/Fall Times	+_ +_	10% to 90%, -2V \leq V _{OUT} \leq 2V, R _L = 100Ω 10% to 90%, -50mV \leq V _{OUT} \leq 50mV, R _L = 100Ω			3			
	t _R , t _F				0.8		– ns	
Differential Gain	DG	f = 3.58MHz	AX4112, Avcl = +2		0.02		- %	
Differential Gain		I = 5.50MHZ	AX4113, A _{VCL} = +8		0.02			
Differential Phase	DP	f = 3.58MHz	AX4112, Avcl = +2		0.03		degree	
Differential Phase	DP	I = 3.30IVITZ	AX4113, Avcl = +8		0.04			
Input Capacitance	CIN				2		pF	
Output Impedance	Zout	f = 10MHz, AvcL = +2			0.9		Ω	
Spurious-Free	SFDR	fc = 5MHz, MA	4X4112, A _{VCL} = +2		-68		dBc	
Dynamic Range	JUK	Vout = 2Vp-p	AX4113, Avcl = +8		-62			
Two-Tone Third-Order Intercept	IP3	$f_C = 10MHz, A_{VCL} = +2$			36		dB	

MAX4112/MAX4113



M/XI/M











_Pin Description

PIN	NAME	FUNCTION			
1, 5, 8	N.C.	No Connection, not internally connected			
2	IN-	Inverting Input			
3	IN+	Noninverting Input			
4	V _{EE}	Negative Power Supply, connect to -5V			
6	OUT	Amplifier Output			
7	Vcc	Positive Power Supply, connect to +5V			

Detailed Description

The MAX4112 is optimized for closed-loop gains (Avc) of 2V/V or greater, while the MAX4113 is optimized for closed-loop gains of 8V/V or greater. These low-power, high-speed current-mode feedback amplifiers operate from ±5V supplies. They are designed to drive video loads with excellent distortion characteristics. The MAX4112's differential gain and phase are 0.02% and 0.03°, respectively; the MAX4113 exhibits gain/phase error specifications of 0.02% and 0.04°, respectively. These characteristics, plus a wide 0.1dB bandwidth, make the MAX4112/MAX4113 ideal for use in broadcast and graphics video systems. The combination of ultra-high speed and low power makes these parts ideal for use in general-purpose high-speed applications, such as medical imaging, industrial instrumentation, and communications systems.

Applications Information

Theory of Operation

Since the MAX4112/MAX4113 are current-feedback amplifiers, their open-loop transfer function is expressed as a transimpedance, $\Delta V_{OUT}/\Delta I_{IN}$, or Z_{OL}. The frequency behavior of the open-loop transimpedance is similar to the open-loop gain of a voltage-mode feedback amplifier. That is, it has a large DC value and decreases at approximately 6dB/octave.

Analyzing the follower with gain, as shown in Figure 1, yields the following transfer function:

$$\frac{V_{OUT}}{V_{IN}} = G \times \frac{Z_{OL}(s)}{Z_{OL}(s) + G \times R_{IN} + R_{F}}$$

where G = Avcl = 1 + RF / RG, and RIN = 1 /g_M \cong 30 Ω .

At low gains, G x R_{IN} << R_F. Therefore, the closed-loop bandwidth is essentially independent of closed-loop gain. Similarly $Z_{OL} >> R_F$ at low frequencies, so that:

$$\frac{V_{OUT}}{V_{IN}} = G = 1 + R_F/R_G$$

M/IXI/M



Figure 1. Current Feedback Amplifier

Layout and Power-Supply Bypassing The MAX4112/MAX4113 have an RF bandwidth and, consequently, require careful board layout, including the possible use of constant-impedance Microstrip or Stripline techniques.

To realize the full AC performance of these high-speed amplifiers, pay careful attention to power-supply bypassing and board layout. The PC board should have at least two layers: a signal and power layer on one side, and a large, low-impedance ground plane on the other side. The ground plane should be as free of voids as possible. With multilayer boards, locate the ground plane on a layer that incorporates no signal or power traces.

Regardless of whether a constant-impedance board is used, it is best to observe the following guidelines when designing the board. Wire-wrap boards are much too inductive, and breadboards are much too capacitive; neither should be used. IC sockets increase parasitic capacitance and inductance, and should not be used. In general, surface-mount components give better high-frequency performance than through-hole components. They have shorter leads and lower parasitic reactances. Keep lines as short and as straight as possible. Do not make 90° turns; round all corners.

Observe high-frequency bypassing techniques to maintain the amplifier's accuracy. The bypass capacitors should include a 1000pF ceramic capacitor between each supply pin and the ground plane, located as close to the package as possible. Next, place a 0.01µF to 0.1µF ceramic capacitor in parallel with each 1000pF capacitor, and as close to them as possible. Then place a 10µF to 15µF low-ESR tantalum at the point of entry (to the PC board) of the power-supply pins. The power-supply trace should lead directly from the tantalum capacitor to the V_{CC} and V_{EE} pins. To minimize parasitic inductance, keep PC traces short and use surface-mount components.

Choosing Feedback and Gain Resistors The MAX4112/MAX4113 are current-feedback amplifiers optimized for a 499 Ω feedback resistor. Although a standard 5% value is sufficient, a 1% value is preferred to maintain consistency over a wide range of production lots. Changing feedback resistor value will reduce the bandwidth or cause excessive peaking. To change the magnitude of the gain, use the input resistor (R_F). Figure 2 shows the standard inverting and noninverting configurations. Notice that the gain of the noninverting circuit (Figure 2a) is 1 plus the magnitude of the inverting closed-loop gain. Otherwise the two circuits are identical and equivalent (see Table 1).

DC and Noise Errors

There are several major error sources to consider in any operational amplifier. These apply equally to the MAX4112/MAX4113. Offset-error terms are given by the equation below. Voltage and current noise errors are

COMPONENT	MAX4112				MAX4113				
	-2	+2	+10	+25	-8	+8	+10	+50	+100
R _F (Ω)	499	499	499	499	499	499	499	499	499
R _G (Ω)	247	499	56	20	62.5	69	56	10	5
R _O (Ω)	49.9	49.9	49.9	49.9	49.9	49.9	49.9	49.9	49.9
R _S (Ω)	0	—	—	—	_	0	—	_	—
R _T (Ω)	62.5	49.9	49.9	49.9	250	49.9	49.9	49.9	49.9
Small-Signal Bandwidth (MHz)	180	500	100	50	325	275	235	50	23
0.1dB Flatness (MHz)	40	30	15	8	90	90	79	8	4

Table 1. Recommended Comp	onent Values
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root-square summed and, therefore, computed separately. In Figure 3, the total output offset voltage is determined by:

- a) The input offset voltage (V_OS) times the closed-loop gain (1 + R_F / R_G)
- b) The positive input bias current (I_{B+}) times the source resistor (R_S) (usually 50Ω or 75Ω), plus the negative input bias current (I_{B-}), times the parallel combination of R_G and R_F. In current-mode feedback amplifiers, the input bias currents may flow into or out of the device; for this reason, there is no benefit to matching the resistance at both inputs.

The equation for total DC error is:

$$V_{OUT} = \left[\left(I_{B+} \right) R_{S} + \left(I_{B-} \right) \left(R_{F} \parallel R_{G} \right) + V_{OS} \right] \left(1 \frac{R_{F}}{R_{G}} \right)$$

c) The total output referred noise voltage is:

$$e_{n(OUT)} = \left(1 + \frac{R_F}{R_G}\right) \sqrt{\left[(i_{n+})R_S\right]^2 + \left[(i_{n-})R_F \mid \mid R_G\right]^2 + (e_n)^2}$$

The MAX4112 has a very low, $2nV/\sqrt{Hz}$ noise voltage. The current noise at the positive input (i_{n+}) is $13pA/\sqrt{Hz}$, and the current noise at the inverting input is $14pA/\sqrt{Hz}$.

An example of the DC error calculations, using the MAX4112 typical data and the typical operating circuit using R_F = R_G =500 Ω (R_F | | R_G = 250 Ω) and R_S = 50 Ω gives:

V_{OUT} = (3.5 x 10⁻⁶ x 50 + 3.5 x 10⁻⁶ x 250 + 10⁻³) (1 + 1) V_{OUT} = 4.1mV

Calculating total output noise in a similar manner yields:

$$\begin{split} & \mathrm{e}_{n(\text{OUT})} = (1\!+\!1) \sqrt{\left(13 x 10^{-12} x 50\right)^2 + \left(14 x 10^{-12} x 250\right)^2 + \left(2 x 10^{-9}\right)^2} \\ & \mathrm{e}_{n(\text{OUT})} = 4 n V / \sqrt{\text{Hz}} \end{split}$$

With a 200MHz system bandwidth, this calculates to $56.6\mu V_{RMS}$ (approximately $340\mu Vp$ -p, choosing the six-sigma value).

Resistor Types

Surface-mount resistors are the best choice for highfrequency circuits. They are of similar material to metalfilm resistors, but are deposited using a thick-film process in a flat, linear manner that minimizes inductance. Their small size and lack of leads also minimizes parasitic inductance and capacitance, yielding more predictable performance.



Figure 2a. Inverting Gain Configuration



Figure 2b. Noninverting Gain Configuration



Figure 3. Output Offset Voltage

WIXIW



Figure 4. Video Line Driver

Metal-film resistors with leads are manufactured using a thin-film process where resistive material is deposited in a spiral layer around a ceramic rod. Although the materials used are noninductive, the spiral winding presents a small inductance (about 5nH) that may have an adverse effect on high-frequency circuits.

Carbon composition resistors with leads are manufactured by pouring the resistor material into a mold. This process yields relatively low-inductance resistors that are very useful in high-frequency applications, although they tend to cost more and have more thermal noise than other types. The ability of carbon composition resistors to self-heal after a large current overload makes them useful in high-power RF applications.

For general-purpose use, surface-mount metal-film resistors seem to have the best overall performance for low cost, low inductance, and low noise.

Video Line Driver

The MAX4112/MAX4113 are optimized (gain flatness) to drive coaxial transmission lines when the cable is terminated at both ends, as shown in Figure 4. Cable frequency response may cause variations in the flatness of the signal.

Driving Capacitive Loads

The MAX4112/MAX4113 are optimized for AC performance. They are not designed to drive highly capacitive loads. Reactive loads will decrease phase margin and may produce excessive ringing and oscillation. Figure 5 shows a circuit that eliminates this problem. The small (usually 5 Ω to 20 Ω) isolation resistor, R_S, placed before the reactive load will prevent ringing and oscillation. At higher capacitive loads, AC performance will be controlled by the interaction of the load capacitance and isolation resistor.







Figure 5b. Frequency Response vs. Capacitive Load—No Isolation Resistor



Figure 5c. Frequency Response vs. Isolation Resistance (see Figure 5a for circuit)

MAX4112/MAX4113

_Chip Information

TRANSISTOR COUNT: 53

Package Information



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